



## Surface Mount General Purpose Silicon Rectifiers

Reverse Voltage - 1000 V

Forward Current - 1.0 A

### FEATURES

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Ideal for automated placement
- Lead free in comply with EU RoHS 2011/65/EU directives

### MECHANICAL DATA

- Case: SOD-123
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 16mg/0.00056oz

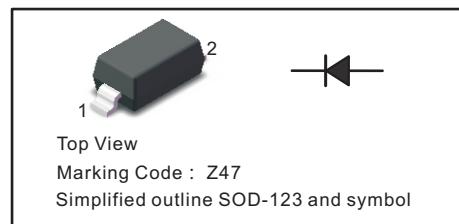
### Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

#### PINNING

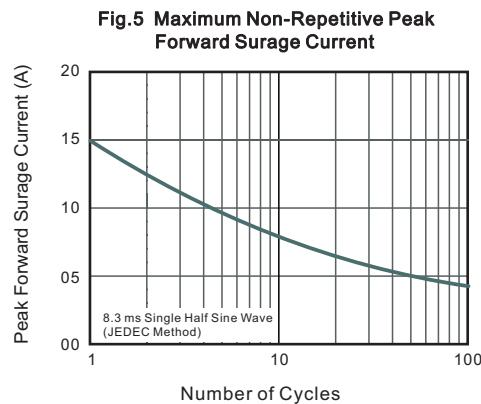
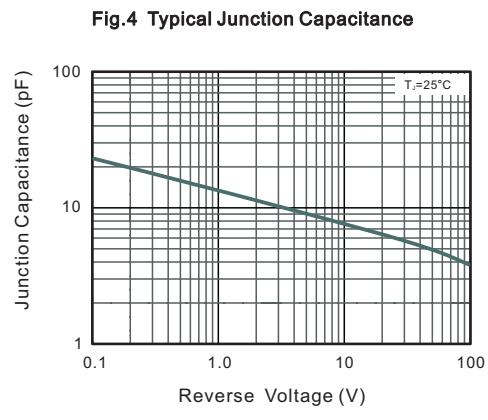
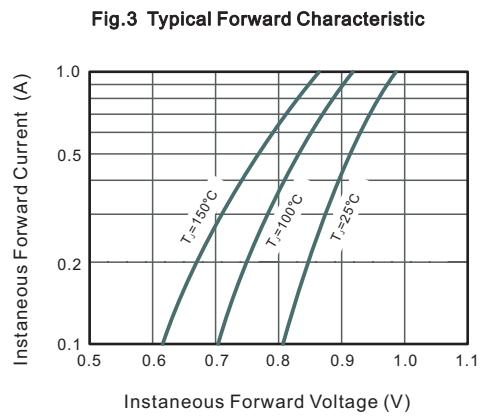
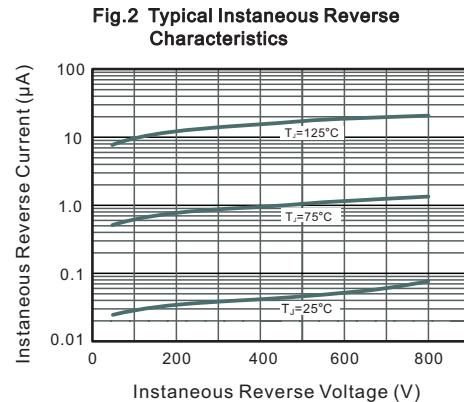
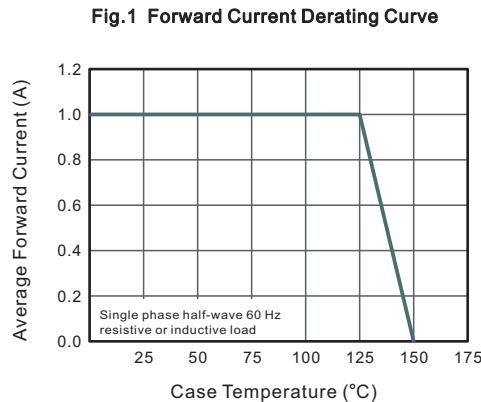
PIN	DESCRIPTION
1	Cathode
2	Anode



Parameter	Symbols	2CZ4007	Units
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	1000	V
Maximum RMS voltage	$V_{RMS}$	700	V
Maximum DC Blocking Voltage	$V_{DC}$	1000	V
Maximum Average Forward Rectified Current at $T_c = 125^\circ\text{C}$	$I_{F(AV)}$	1.0	A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	$I_{FSM}$	15	A
Maximum Instantaneous Forward Voltage at 1.0 A	$V_F$	1.1	V
Maximum DC Reverse Current $T_a = 25^\circ\text{C}$ at Rated DC Blocking Voltage	$I_R$	5	$\mu\text{A}$
Typical Junction Capacitance <sup>(1)</sup>	$C_j$	11	pF
Typical Thermal Resistance <sup>(2)</sup>	$R_{\theta JA}$	90	$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	$T_j, T_{stg}$	-55 ~ +150	$^\circ\text{C}$

( 1 ) Measured at 1 MHz and applied reverse voltage of 4 V D.C

( 2 ) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

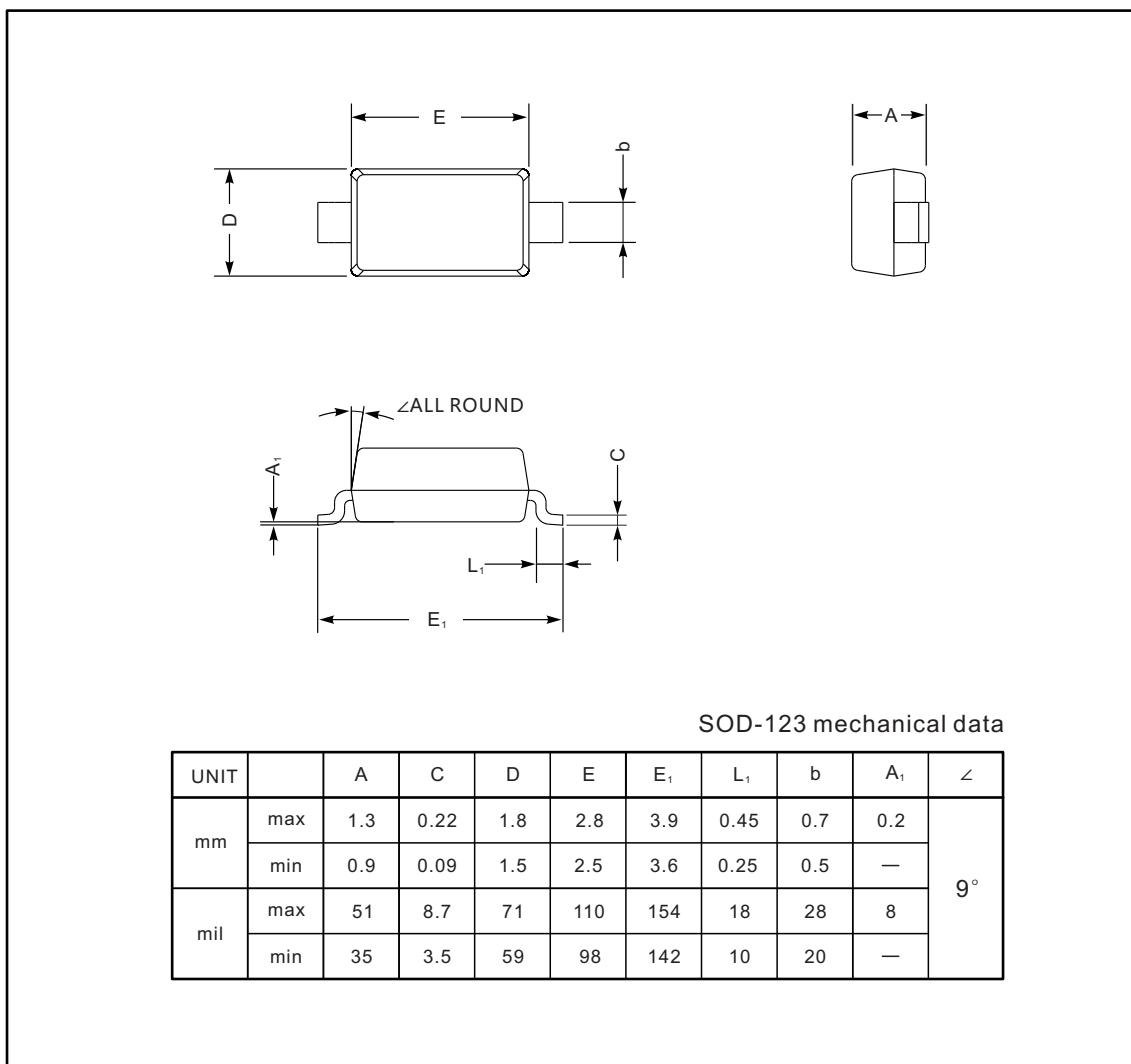




## PACKAGE OUTLINE

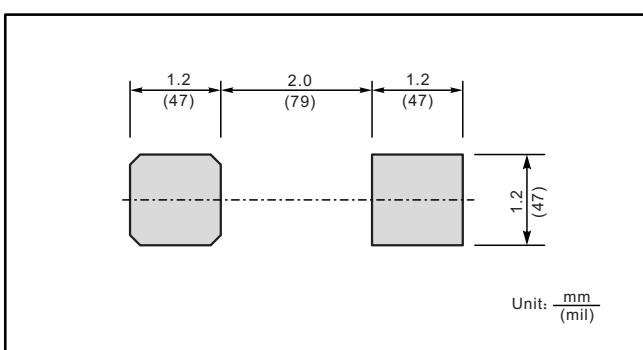
Plastic surface mounted package; 2 leads

SOD-123



### The recommended mounting pad size

### Marking



Type number	Marking code
2CZ4007	Z47